26.9 A 0.19×0.17mm² Wireless Neural Recording IC for Motor Prediction with Near-Infrared-Based Power and Data **Telemetry**

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Brain machine interfaces using neural recording systems [1-4] can enable motor prediction [5-6] for accurate arm and hand control in paralyzed or severely injured individuals. However, implantable systems have historically used wires for data communication and power, increasing risks of tissue damage, infection, and cerebrospinal fluid leakage, rendering these devices unsuitable for long-term implantation (Fig. 26.9.1, top). Recently, several wireless and miniaturized neural recording implants with various power and data transmission methods were proposed. References [7,8] propose an electrocorticography (ECoG) recording system with near-field RF power transfer and bilateral communication, but the 0.5W Tx exceeds maximum exposure limits by 10x [8]. Ultrasonic telemetry can safely send more power than RF; however it requires mm-scale dimensions (0.8mm³ in [9]) due to bulky ultrasound transducers. On the other hand, near infrared (NIR) light can provide power transfer and data downlink via a photovoltaic cell (PV), and a data uplink via a light-emitting diode (LED). Dimensions can be scaled to 100s of microns [10], with [11] demonstrating a 0.0297mm² neural recording system using a 50mW/mm² light source (<1/6th of safety limit for the brain). However, this system is limited to a single channel, and since it only has a surface electrode, it can record only surface potentials (facedown, potentially blocking the light channel) or must itself be injected into brain tissue, creating significant tissue damage and danger of bleeding. In this paper, we propose a 0.74μW, 0.19×0.17mm² IC designed for a wireless neural recording probe. It computes so-called spiking band power (SBP) [5,12] on-chip to save 920× power while maintaining accurate finger position and velocity decoding.

A neural probe IC is designed for a larger neural recording system concept (Fig. 26.9.1, bottom) in which numerous micro-probes would be placed on the brain in the sub-dural space to record neural spikes using a carbon fiber electrode that penetrates several mm into brain tissue and has been shown to incur minimal chronic scar formation [13]. The probes will be powered and globally programmed by 850nm NIR light emitted by a repeater placed in the epidural space. The LED in the probe will act as the data uplink; its light received by the repeater using a single-photon avalanche diode (SPAD). The repeater would service 100s of probes, which are distinguished by their on-chip ID and location. Given its larger size, the repeater can use an inductive link for wireless power and data communication with an external receiver.

The CMOS IC consists of an optical receiver followed by clock and data recovery, a random-number-generated-based chip ID [14], neural recording amplifier, SBP extractor, and LED driver (Fig. 26.9.2). Figure 26.9.3 shows the schematic and measured signal diagram of the optical receiver (ORx). V_{DD} is AC-coupled to a comparator input to convert modulated light from the repeater to a digital signal. The comparator has 80mV hysteresis to remove glitches due to unwanted V_{DD} fluctuations. In the power-on reset phase, the clock recovery circuit locks the onchip recovery clock to the precise 8kHz modulated light from the repeater. This is critical since the clock is used to set the reference current, which must be precisely controlled for reliable amplification and signal filtering. The clock recovery circuit searches the digitally-controlled oscillator (DCO) thermometer-coded configurations to match the received modulation period with the DCO period. It then switches the system clock from the default to recovery clock using glitchfree multiplexers. After clock locking, the repeater programs the system using pulse width modulated (PWM) light (downlink). An 8b hardwired passcode is implemented to prevent unwanted programming. The signal diagrams in Fig. 26.9.3 are measured from the proposed chip, wire-bonded with a custom dualjunction GaAs PV cell that generates 893nA I_{sc} and 1.67V V_{oc} under 120.5µW/mm²

The AFE is specifically designed to support SBP [5] based finger position / velocity decoding. SBP is the absolute average of signal amplitude in the 300-to-1000Hz band. When used as input to a trained linear decoding filter, SBP maintains finger position / velocity decoding accuracy relative to a standard 7.5kHz bandwidth neural recording while reducing the required communication bandwidth from probe to repeater to only 100s of Hz, thereby reducing uplink power. The AFE is composed of a three-stage bandpass differential amplifier chain with subsequent source follower and rectifier-based integrator to quantize the SBP (Fig. 26.9.4 left). The LNA, with $60M\Omega$ input impedance at 1kHz, is fully differential and achieves 30dB gain without bulky capacitors by implementing its gain using g_m ratio. VGA1 and VGA2 set the high-cut-off (f_H, 950Hz) and low-cut-off frequencies (f_L, 180Hz), respectively, and define the spiking band. f_H is set by VGA2 bias current, which is generated by a current reference implemented using a voltage reference and switched capacitor operating at f_{CLK}. f_L is defined by the VGA2 DC servo loop, whose feedback impedance is defined by $1/C_{\text{SW}}f_{\text{CLK}}$. Accuracy of f_{H} and f_L is ensured by locking f_{CLK} during clock recovery to the repeater. Peak gain is measured at 69dB while amplifying action potential (AP) spikes in 180-950Hz bandwidth for SBP-based motor prediction. Measured input-referred noise (IRN) is 4.8µVrms while consuming 510nW at 38°C.

The 3-stage amplifier drives a rectifier (Fig. 26.9.4 bottom left) whose output is initially precharged to VREF_H. The rectifier output decays at a rate proportional to its input amplitude. When it drops below VREF, a pulse is generated on LED_EN. This triggers the LED driver to transmit a Manchester encoded (unique) chipID (Fig. 26.9.5 top left) consuming 6.7pJ/bit (post layout simulation). Therefore, the LED firing rate or frequency is proportional to the SBP. AFE functionality was also verified in vivo using a carbon fiber driven ~1.3mm into the motor cortex of an anesthetized Long Evans rat. A commercial recording system (24.414kSps. [2.2Hz, 7.5kHz] BW) is connected to the carbon fiber electrode in parallel to the IC for accuracy comparison. All procedures complied with the Institutional Animal Care and Use Committee. VIN is the input of the proposed amplifier, measured by the high-power commercial recording system. VOUT(VOUT_P-VOUT_N) is the amplifier measured output. Results show that the rectifier output (INTOUT) steps down at each motor cortex neuron spike and is restored to VREF_H when it reaches VREF, (Fig. 26.9.4).

LED firing rate linearity across SBP is tested using synthesized AP spikes $(240\mu V_{pk\text{-to-pk}}, 1\text{ms width})$ with varying rates from 0 to 100Hz (Fig. 26.9.5 top right). The measured LED firing rate is proportional to SBP with nonlinearity <2.9% and its sensitivity is programmable from 0.4 to 5.0 firings per μV. Overall functionality is verified using three different types of input signals; synthesized neural simulator, in vivo rat motor cortex, and pre-recorded monkey motor cortex (Fig. 26.9.5 bottom). Measured probe SBP is decoded from the measured time interval of LED_EN signal and compared with the result generated by a conventional high-power analog front-end and DSP SBP calculation [5]. The measured probe SBP accurately matches the conventional system results. Figure 26.9.6 (top) shows finger position / velocity decoding results using Kalman-Filter (KF) [6] with conventional and probe SBP from pre-recorded 20-channel neural signals of a male monkey. All procedures complied with the Institutional Animal Care and Use Committee. The system accurately predicts finger position / velocity with state-of-the-art correlation coefficient of 0.8587 / 0.5919 while a conventional high-power and wired system demonstrates 0.8886 / 0.6155 correlation coefficient. The IC is fabricated in 180nm CMOS (Fig. 26.9.7). Figure 26.9.6 (bottom) compares to previously published wireless neural probe chip designs. It consumes 0.74µW with 3.76 amplifier NEF at 1.5V supply and 38°C, achieving best noise performance among comparable designs [7,9,11].

Acknowledgements:

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References:

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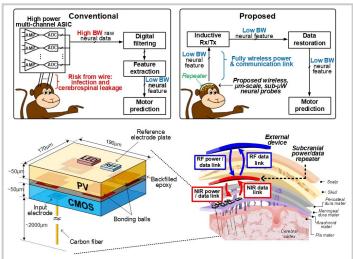


Figure 26.9.1: Conventional and proposed neural recording system (top); concept diagram of proposed neural probe and two-step approach for recording and transmitting neural signals (bottom).

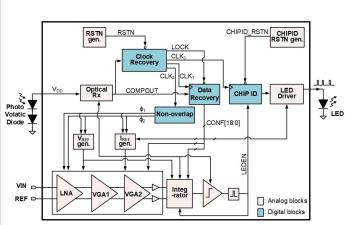


Figure 26.9.2: Top-level circuit diagram of the neural recorder.

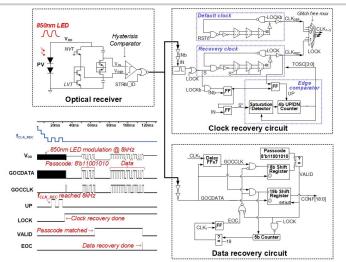


Figure 26.9.3: Optical receiver (top left), clock recovery circuit (top right), data recovery structure (bottom right), and measured signal diagram during clock and data recovery (bottom left).

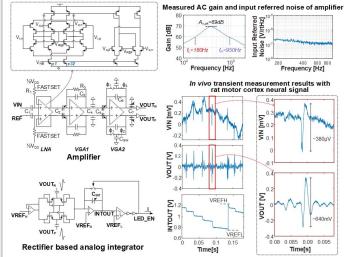


Figure 26.9.4: Amplifier (top left), rectifier based analog integrator (bottom left), measured amplifier AC and noise performance (top right), *in vivo* measurement results from a motor cortex of rat (bottom right).

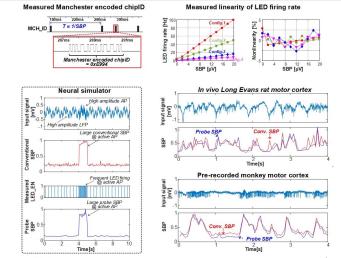


Figure 26.9.5: Measured timing diagram of Manchester encoded chip ID (top left), measured linearity of LED firing rate across SBP (top right), and measured transient waveform from three types of input neural signals (bottom).

	≥ 100				
		105	110 Time[s] 115	120	125
		This work	NER 2019 [7]	ISSCC 2019 [9]	ISSCC 2018 [11
Technology [nm]		180	65	65	180
Wireless power source		Optical	RF	Ultrasonic	Optical
Data transim mision m ethod		Optical	RF	Ultrasonic	Optical
Data transim m ision	Up-link	SIM (Symbol Interval Modulation)	BPSK-m odulated RF backscatter	AM backscatter	PPM
	Down-link	PWM	ASK-PWM	No	No
On-chip feature extraction		SBP	No	No	No
Chip ID		16b	24b	No	No
Clock recovery		Yes	No	No	No
Supply [V]		1.5	0.6	1	0.9
Power [µW]	Total	0.74	40	28.8	< 1
	Am plifier	0.51	3.2	4	< 0.52
Area [mm²] (W [mm] x L [mm])		0.0323 (0.19 x 0.17)	0.25 (0.5 x 0.5)	PZT: 0.5625 (0.75 x 0.75) IC :0.25 (0.5 x 0.5)	0.0297 (0.330 x 0.090)
Target neural signal		AP	ECoG (epicortical)	LFP, AP	LFP, AP
Gain[dB]		69	N/A	24	24
Bandwidth[Hz]		180 ~ 950°	500	5000	10000
Input referred noise [µVrm s]		4.8†	2.2	5.3	42
NEF		3.76	8.7	5.87	12.3

Figure 26.9.6: Finger position / velocity decoding result using KF with the probe and conventional SBP with pre-recorded 20-channel neural signals of a monkey (top) and comparison table (bottom).

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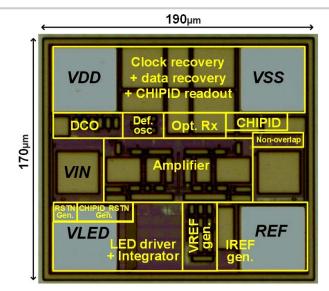


Figure 26.9.7: Die photo of the IC in 180nm CMOS.

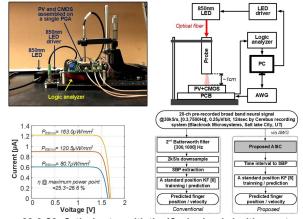


Figure 26.9.S2: Optical setup with the IC wire-bonded with a custom dualjunction GaAs PV (top), measured performance of the PV (bottom left), and flow chart of finger position and velocity decoding (bottom, right). Pre-recorded neural signal from the motor cortex of a rhesus macaque and one-dimensional aperture of fingers at 1kHz during a finger-based target acquisition task are used.

Additional References:

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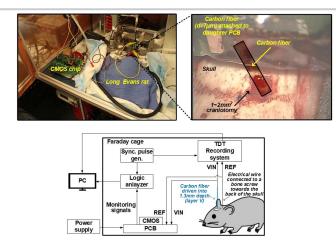


Figure 26.9.S1: Photo of *in vivo* testing setup (top left). Carbon fiber mounted to PCB is inserted (top right) and a bone screw was placed at the most posterior portion of the skull. Recordings were taken with the IC in parallel with RA16AC headstage, RA16PA pre-amplifier, and RX7 Pentusa base station (Tucker-Davis Technologies, Alachua, FL, 2.2-7500Hz bandpass filtered) (bottom).

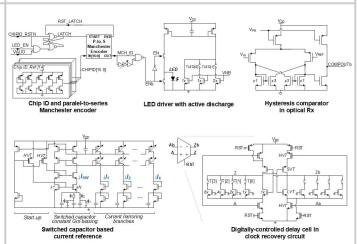


Figure 26.9.S3: Structure of chip ID and readout circuit (top left), current sourcing based LED driver with active discharge (top middle), comparator with hysteresis (top right), switched capacitor based current reference (bottom left), and leakage based DCO delay cell (bottom right).